



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

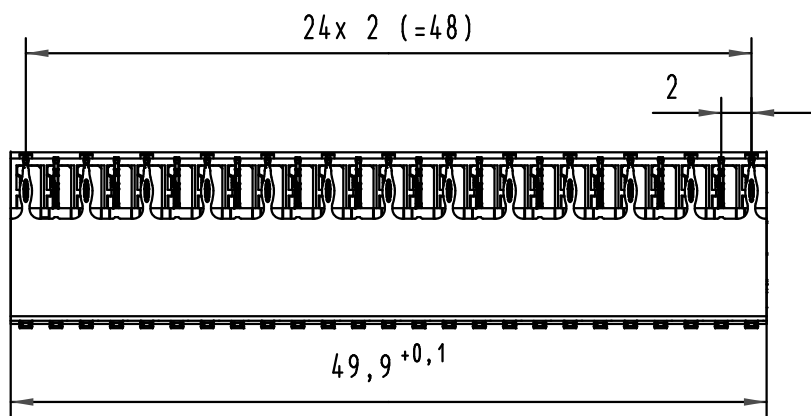
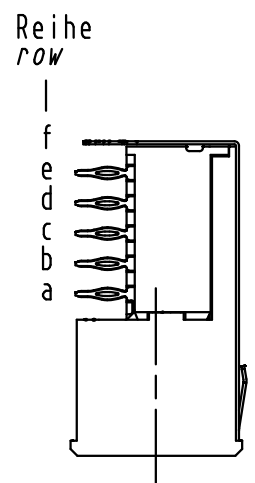
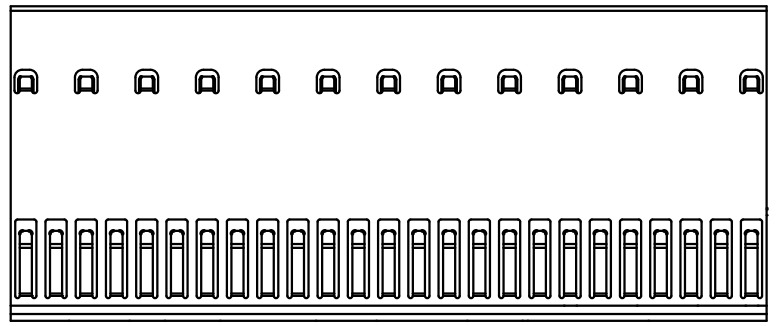
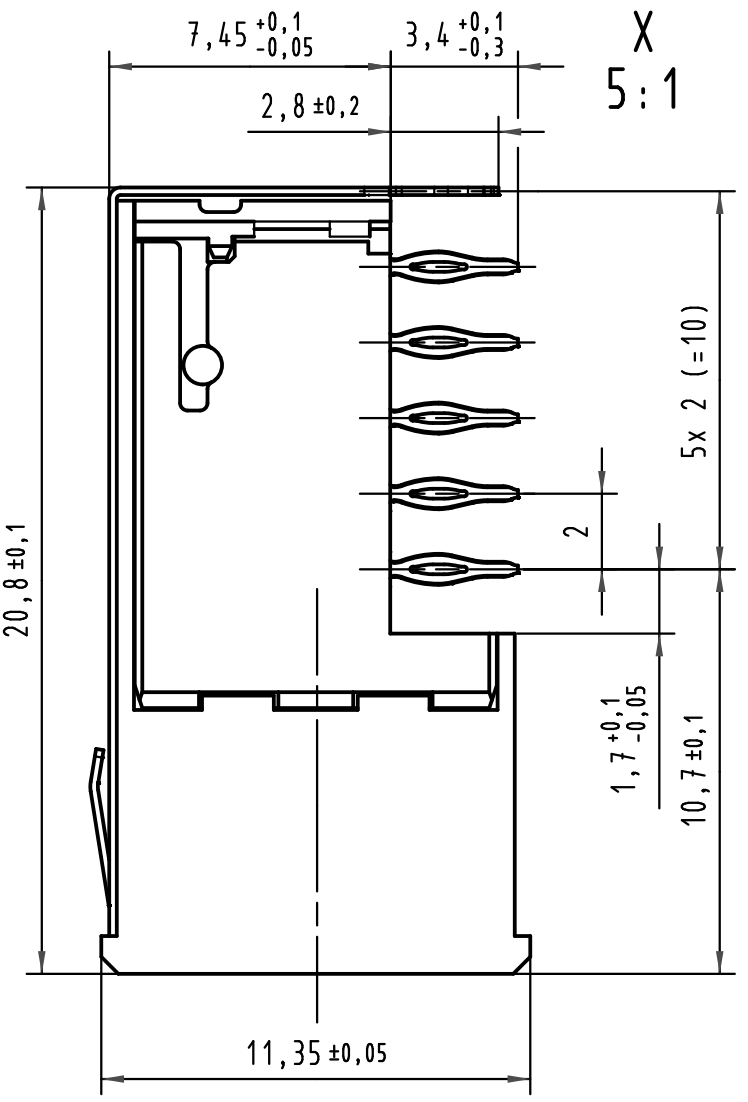
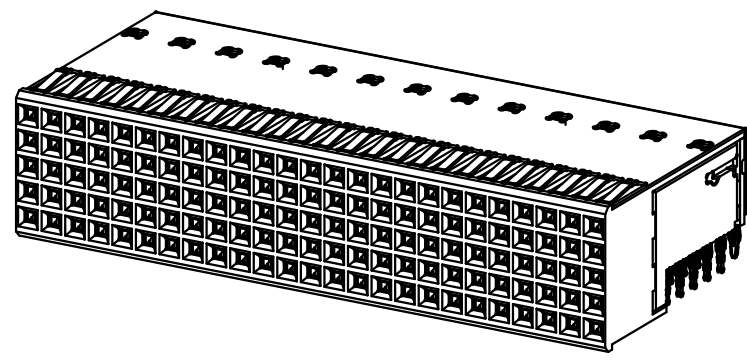
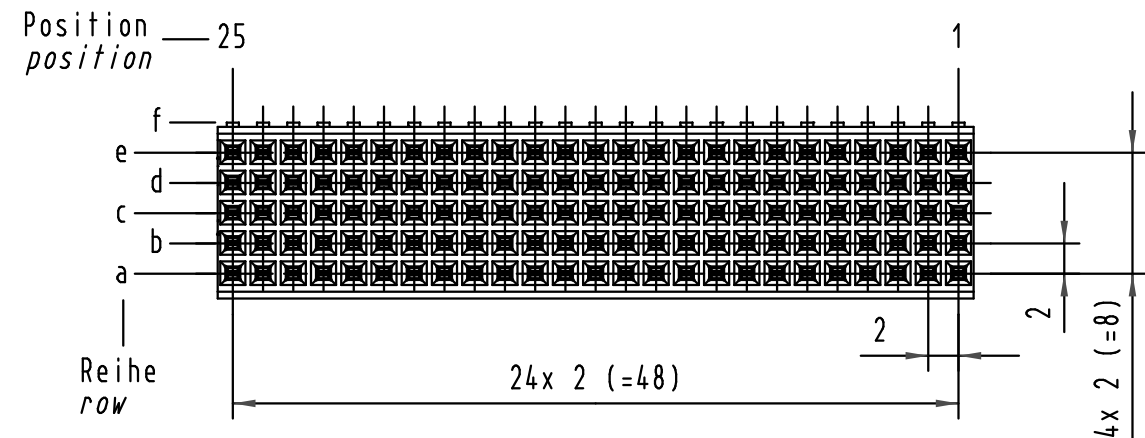
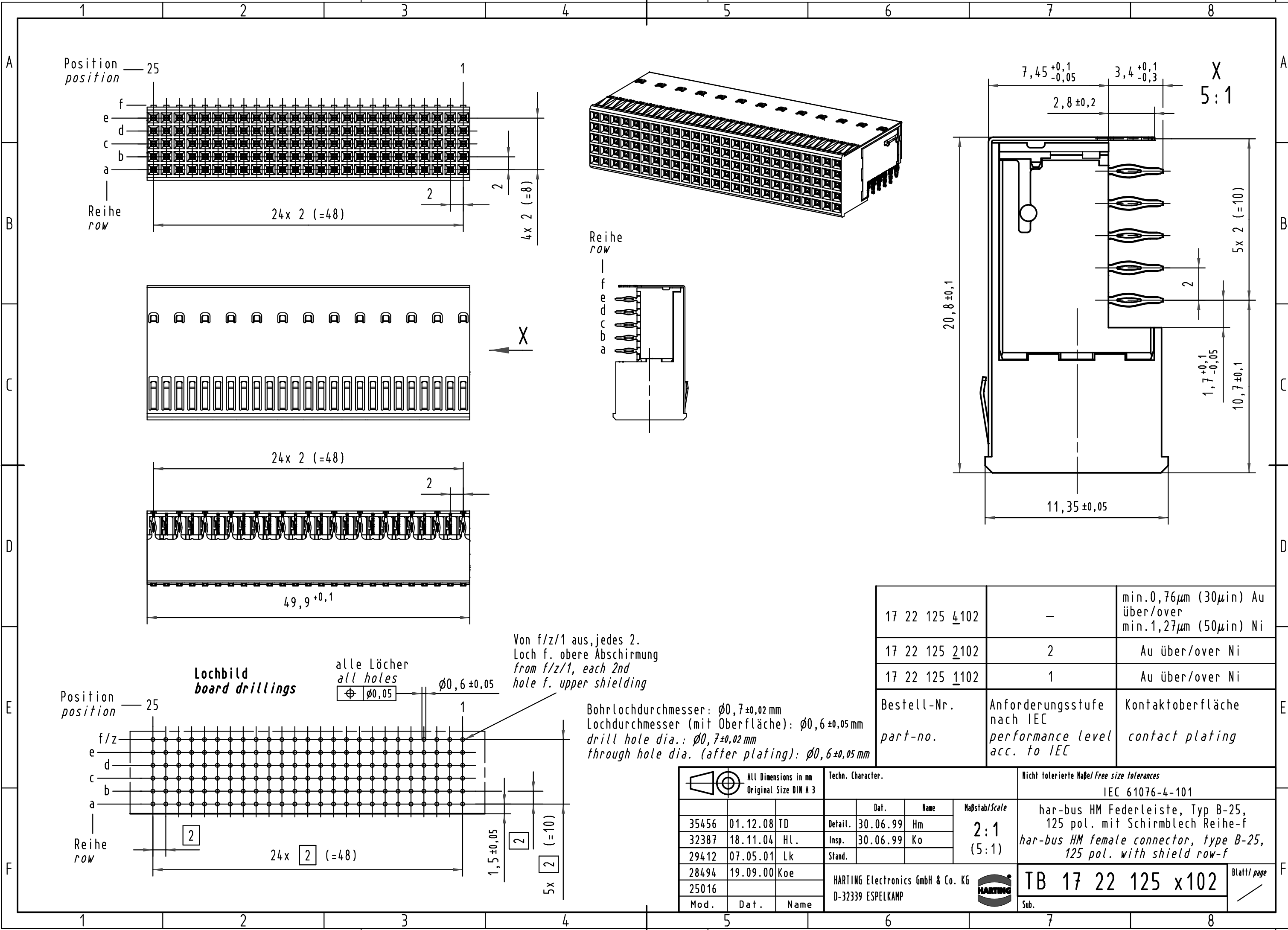
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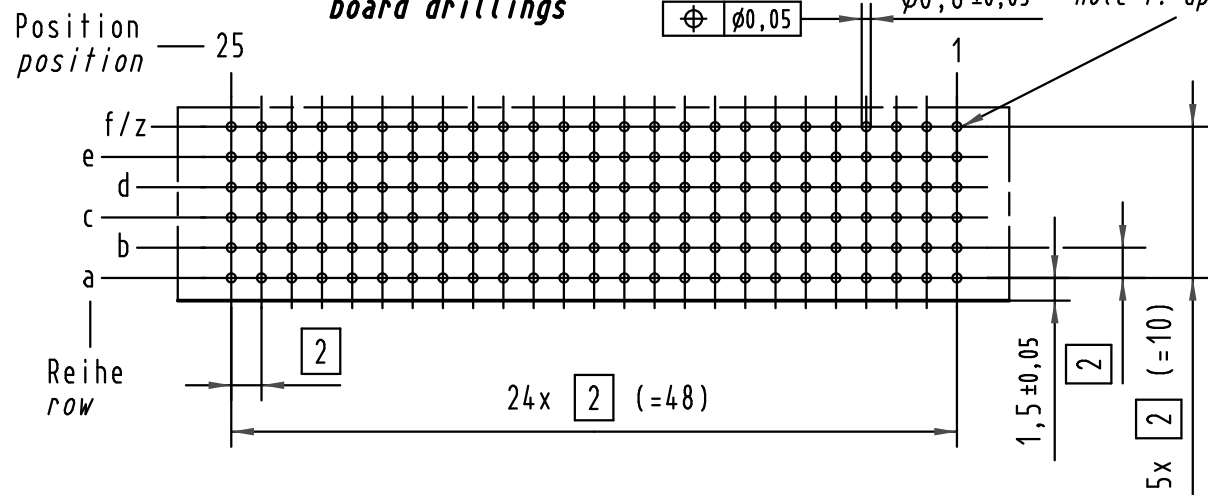
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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Lochbild board drillings



alle Löcher all holes

⊕ ⌀0,05

⌀0,6 ±0,05

Von f/z/1 aus, jedes 2. Loch f. obere Abschirmung
from f/z/1, each 2nd hole f. upper shielding

Bohrlochdurchmesser: ⌀0,7 ±0,02 mm
Lochdurchmesser (mit Oberfläche): ⌀0,6 ±0,05 mm
drill hole dia.: ⌀0,7 ±0,02 mm
through hole dia. (after plating): ⌀0,6 ±0,05 mm

17 22 125 4102	—	min.0,76µm (30µin) Au über/over min.1,27µm (50µin) Ni
17 22 125 2102	2	Au über/over Ni
17 22 125 1102	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche nach IEC contact plating

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maß/Free size tolerances IEC 61076-4-101		
35456	01.12.08	TD	Detail.	30.06.99	Hm	2:1 (5:1)	har-bus HM Federleiste, Typ B-25, 125 pol. mit Schirmblech Reihe-f har-bus HM female connector, type B-25, 125 pol. with shield row-f	
32387	18.11.04	HL.	Insp.	30.06.99	Ko			
29412	07.05.01	Lk	Stand.					
28494	19.09.00	Koe						
25016								
Mod.	Dat.	Name	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP			TB 17 22 125 x102		Blatt/ page
						Sub.		